



ZXM62N02E6

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	Max R _{DS(on)}	Max I _D T _A = +25°C
20V	0.1Ω @ V _{GS} = 4.5V	3.2A
200	$0.125\Omega @ V_{GS} = 2.7V$	2.8A

Description and Applications

This high-density MOSFET from Zetex utilizes a unique structure that combines the benefits of low, on-resistance with fast switching speed. This makes it ideal for high-efficiency, low voltage power management applications such as:

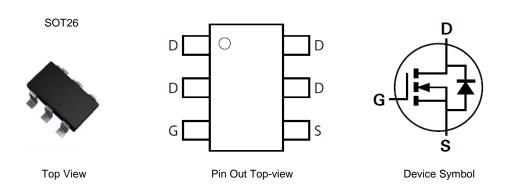
- DC-DC Converters
- Power Management Functions
- Disconnect Switches
- Motor Control

Features and Benefits

- Low On-Resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- SOT26 Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.015 grams (Approximate)



Ordering Information (Note 4)

Part Number	Reel Size (inch)	Tape Width (mm)	Quantity Per Reel
ZXM62N02E6TA	7	8	3,000
ZXM62N02E6TC	13	8	10,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information

	iniane											
			SC	DT26								
					2N02 = Product Type Mark							
Date Code Key			2N	102 ⋛		YM = Date Code I Y or $\overline{Y} = Year (ex:$			Code Marking			
Year	2015		2016	2017		2018	2019		2020	2021		2022
Code	С		D	E		F	G		Н	I		J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D
ZXM62N02E6						1 of 7						March 20

Datasheet Number: DS33480 Rev. 2 - 2

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Charact	eristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	20	V		
Gate-Source Voltage			V _{GS}	±12	V	
Continuous Drain Current		(Note 6)	ID	3.2	٨	
	$V_{GS} = 4.5V$	T _A = +70°C (Note 6)		2.6	A	
Pulsed Drain Current		(Note 7)	I _{DM}	18	А	
Continuous Source Current (Body Diode) (Note 6)			ls	2.1	А	
Pulsed Source Current (Body Diode)			I _{SM}	18	А	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

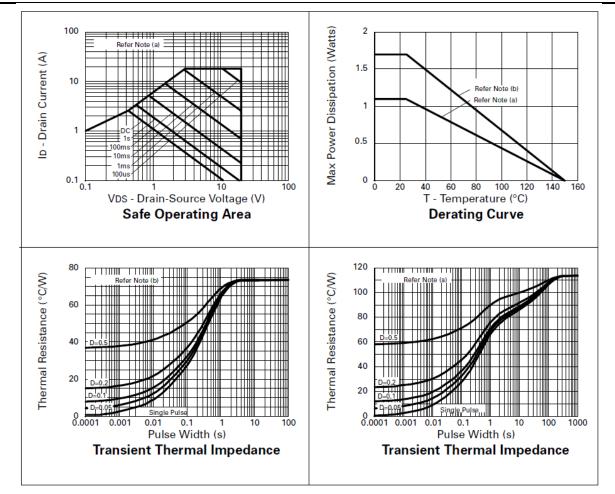
Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	D	1.1	W	
Linear Derating Factor	PD	8.8	mW/°C	
Power Dissipation (Note 6)		D	1.7	W
Linear Derating Factor	PD	13.6	mW/°C	
Thermal Desistance, Junction to Ambient	(Note 5)	P.	113	80 M/
Thermal Resistance, Junction to Ambient	(Note 6)	R ₀ JA	73	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

5. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions. 6. For a device surface mounted on FR4 PCB measured at t ≤ 5 seconds.

7. Repetitive rating - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.

Thermal Characteristics

Notes:





Electrical Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

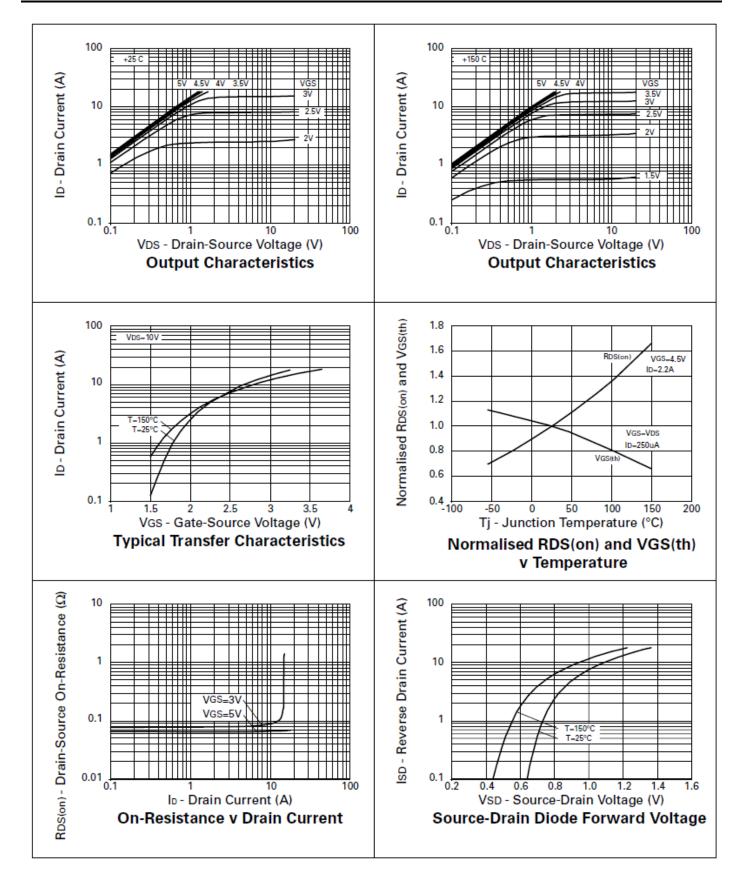
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS			- 76				
Drain-Source Breakdown Voltage	BV _{DSS}	20		_	V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I _{DSS}	_		1	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Body Leakage	I _{GSS}	_		100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS							
Gate-Source Threshold Voltage	V _{GS(th)}	0.7	—		V	$I_D = 250 \mu A$, $V_{DS} = V_{GS}$	
Static Drain-Source On-Resistance (Note 8)	Passa			0.1	Ω	$V_{GS} = 4.5V, I_D = 2.2A$	
	R _{DS(ON)}	_		0.125	12	$V_{GS} = 2.7V, I_D = 1.1A$	
Forward Transconductance	g fs	3.2		—	S	$V_{DS} = 10V, I_D = 1.1A$	
Diode Forward Voltage (Note 8)	V _{SD}	_		0.95	V	$T_J = +25^{\circ}C, I_S = 2.2A, V_{GS} = 0V$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	460	_	pF		
Output Capacitance	C _{oss}	_	150	_	pF	$V_{DS} = 15V, V_{GS} = 0V$ - f = 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	50	_	pF		
Total Gate Charge (Note 9)	Qg	_	_	6.3	nC	V _{DS} = 16V, V _{GS} = 4.5V,	
Gate-Source Charge (Note 9)	Q _{gs}	_	_	1.5	nC	$I_D = 2.2A$ (refer to	
Gate-Drain Charge (Note 9)	Q _{gd}	_		2.5	nC	test circuit)	
Turn-On Delay Time (Note 9)	t _{d(on)}		4.0		ns		
Turn-On Rise Time (Note 9)	tr		10.4	_	ns	$V_{DD} = 10V, I_D = 2.2A,$	
Turn-Off Delay Time (Note 9)	t _{d(off)}	_	16.9	_	ns	$R_G = 6.0 \Omega$, $R_D = 4.4 \Omega$ (refer to test circuit)	
Turn-Off Fall Time (Note 9)	tf	_	8.0	_	ns		
Reverse Recovery Time	t _{rr}	_	17.5		ns	T _J = +25°C, I _F = 2.2A,	
Reverse Recovery Charge	Q _{rr}	_	8.6	_	nC	di/dt = 100A/µs	

Notes:

8. Measured under pulsed conditions. Width \leq 300µs. Duty cycle \leq 2%. 9. Switching characteristics are independent of operating junction temperature. 10. For design aid only, not subject to production testing.

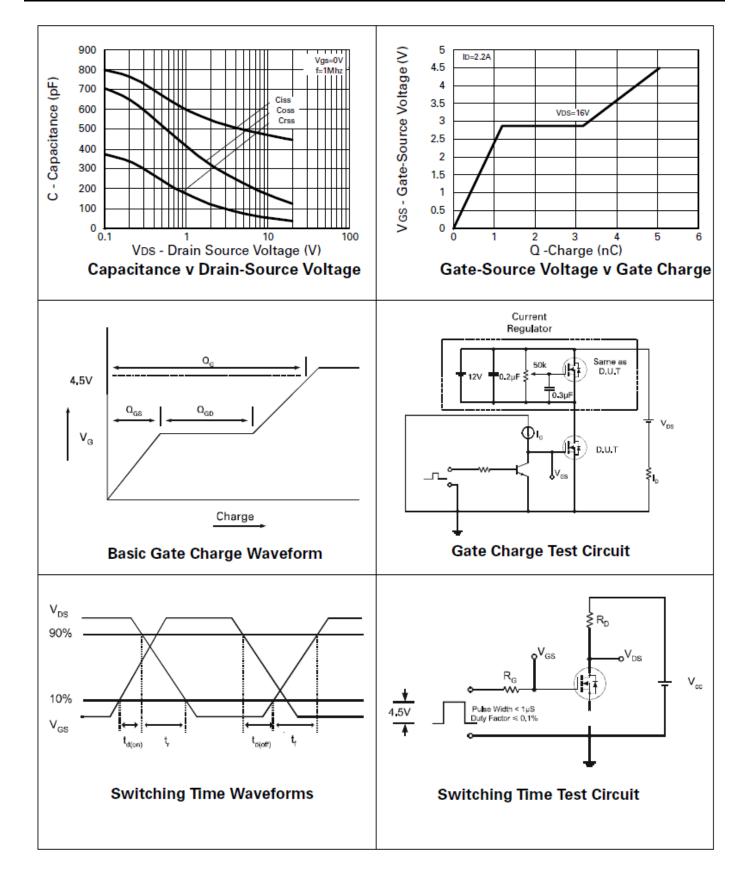


Typical Characteristics





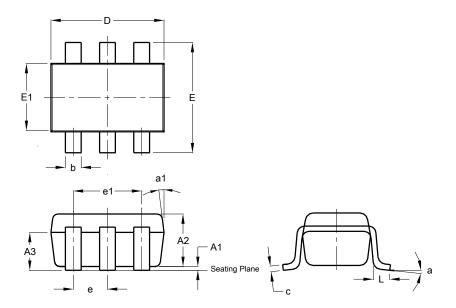
Typical Characteristics (cont.)





Package Outline Dimensions

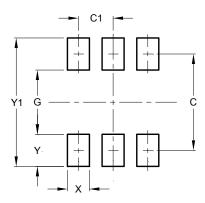
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT26							
Dim	Min	Max	Тур					
A1	0.013	0.10	0.05					
A2	1.00	1.30	1.10					
A3	0.70	0.80	0.75					
b	0.35	0.50	0.38					
С	0.10	0.20	0.15					
D	2.90	3.10	3.00					
е	-	-	0.95					
e1	-	-	1.90					
E	2.70	3.00	2.80					
E1	1.50	1.70	1.60					
L	0.35	0.55	0.40					
а	-	-	8°					
a1	-	-	7°					
All	All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20



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